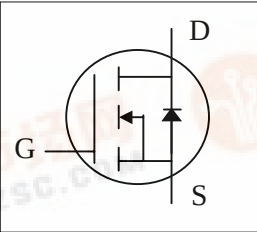




Advanced Power
Electronics Corp.

- ▼ Low On-resistance
- ▼ Simple Drive Requirement
- ▼ Fast Switching

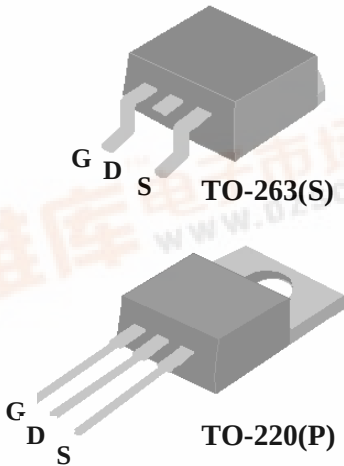


BV_{DSS}	25V
$R_{DS(ON)}$	9m Ω
I_D	66A

Description

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-263 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters. The through-hole version (AP70L02GP) is available for low-profile applications.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	25	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^{\circ}C$	Continuous Drain Current, V_{GS} @ 10V	66	A
$I_D@T_C=100^{\circ}C$	Continuous Drain Current, V_{GS} @ 10V	42	A
I_{DM}	Pulsed Drain Current ¹	210	A
$P_D@T_C=25^{\circ}C$	Total Power Dissipation	66	W
	Linear Derating Factor	0.53	W/ $^{\circ}C$
T_{STG}	Storage Temperature Range	-55 to 150	$^{\circ}C$
T_J	Operating Junction Temperature Range	-55 to 150	$^{\circ}C$

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal Resistance Junction-case	Max. 1.9	$^{\circ}C/W$
Rthj-amb	Thermal Resistance Junction-ambient	Max. 62	$^{\circ}C/W$



AP70L02GS/P

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	25	-	-	V
ΔBV _{DSS} /ΔT _j	Breakdown Voltage Temperature Coefficient	Reference to 25°C, I _D =1mA	-	0.037	-	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =33A	-	-	9	mΩ
		V _{GS} =4.5V, I _D =20A	-	-	18	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	-	3	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =33A	-	25	-	S
I _{DSS}	Drain-Source Leakage Current (T _j =25°C)	V _{DS} =25V, V _{GS} =0V	-	-	1	uA
	Drain-Source Leakage Current (T _j =150°C)	V _{DS} =20V, V _{GS} =0V	-	-	25	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =± 20V	-	-	±100	nA
Q _g	Total Gate Charge ²	I _D =33A	-	23		nC
Q _{gs}	Gate-Source Charge	V _{DS} =20V	-	3		nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =5V	-	17		nC
t _{d(on)}	Turn-on Delay Time ²	V _{DS} =15V	-	8.8	-	ns
t _r	Rise Time	I _D =33A	-	95	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =3.3Ω, V _{GS} =10V	-	24	-	ns
t _f	Fall Time	R _D =0.45Ω	-	14	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	790	-	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	475	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	195	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I _S	Continuous Source Current (Body Diode)	V _D =V _G =0V , V _S =1.26V	-	-	66	A
I _{SM}	Pulsed Source Current (Body Diode) ¹		-	-	210	A
V _{SD}	Forward On Voltage ²	T _j =25°C, I _S =66A, V _{GS} =0V	-	-	1.26	V

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test

THIS PRODUCT IS AN ELECTROSTATIC SENSITIVE, PLEASE HANDLE WITH CAUTION.

THIS PRODUCT HAS BEEN QUALIFIED FOR CONSUMER MARKET. APPLICATIONS OR USES AS CRITERIAL COMPONENT IN LIFE SUPPORT DEVICE OR SYSTEM ARE NOT AUTHORIZED.

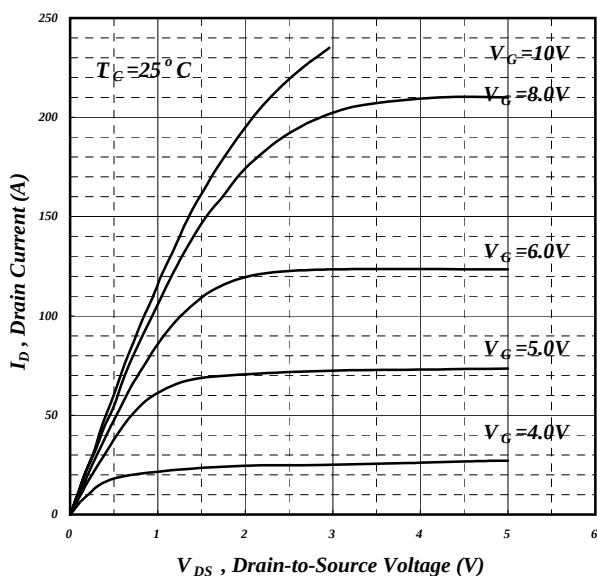


Fig 1. Typical Output Characteristics

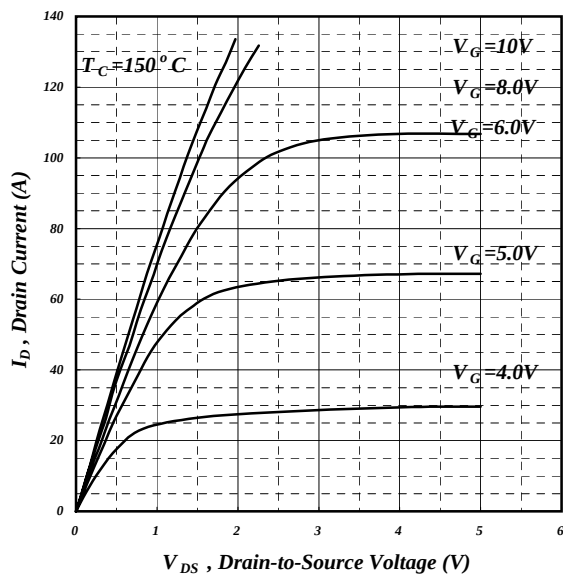


Fig 2. Typical Output Characteristics

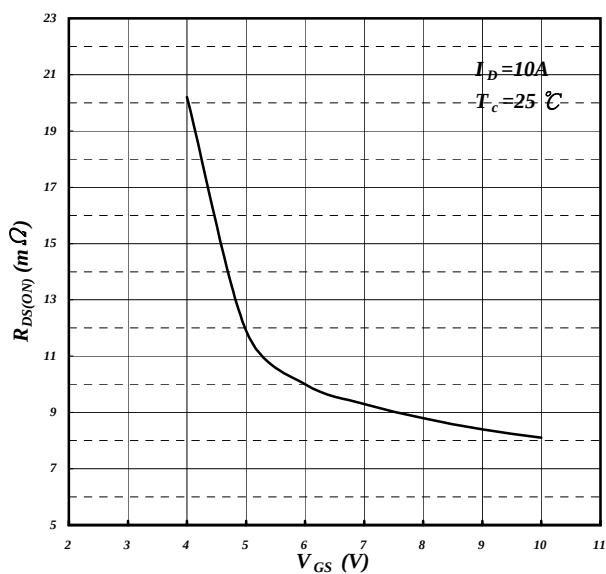


Fig 3. On-Resistance v.s. Gate Voltage

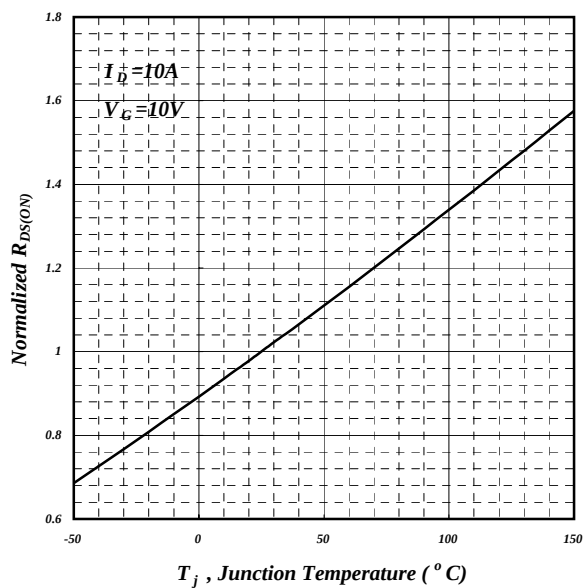


Fig 4. Normalized On-Resistance
v.s. Junction Temperature

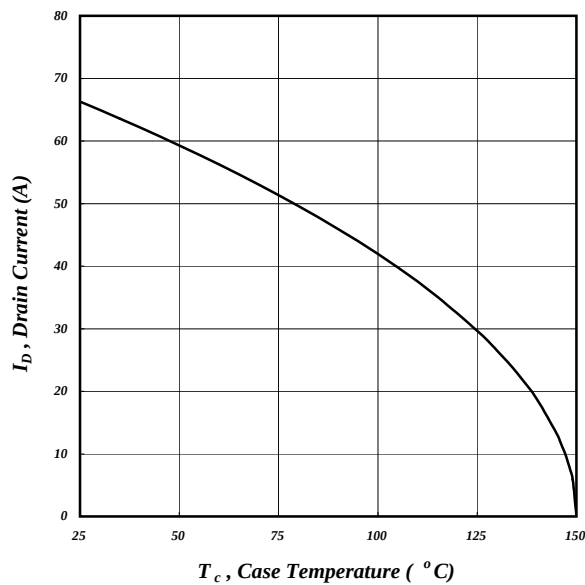


Fig 5. Maximum Drain Current v.s. Case Temperature

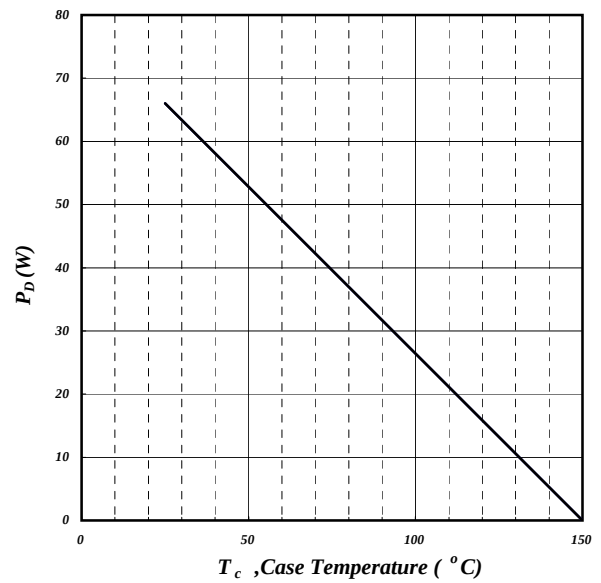


Fig 6. Typical Power Dissipation

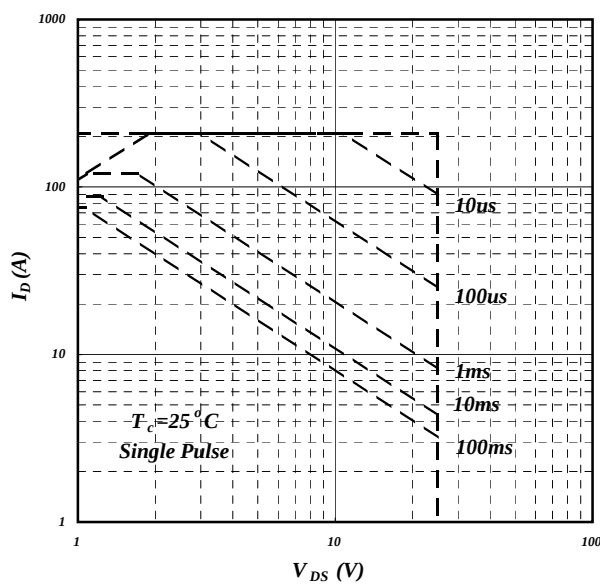


Fig 7. Maximum Safe Operating Area

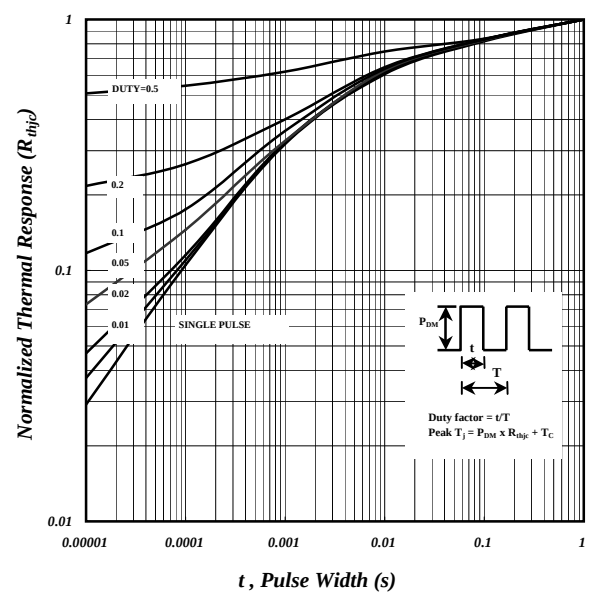
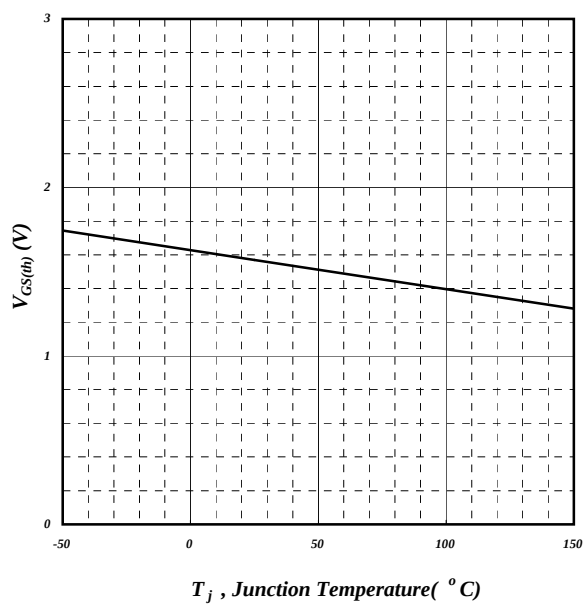
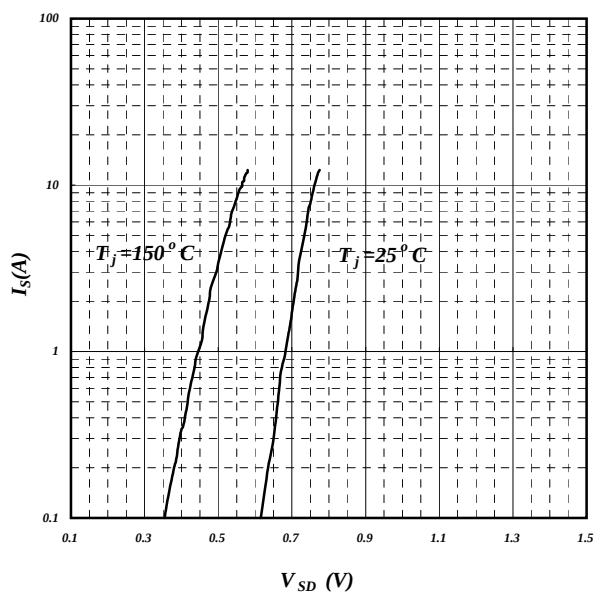
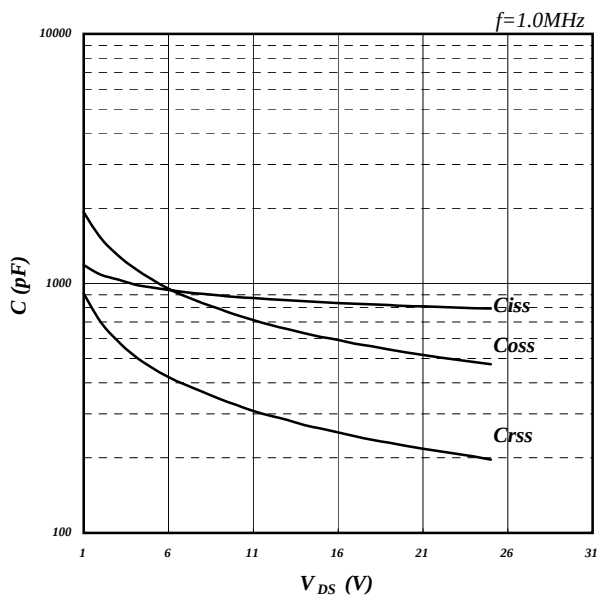
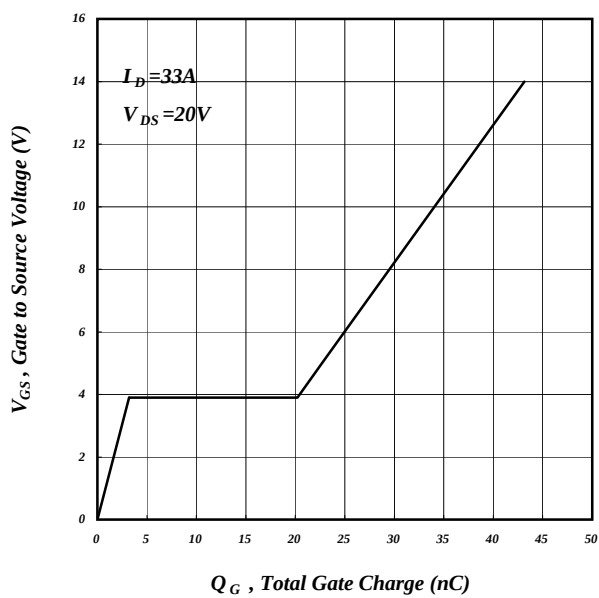


Fig 8. Effective Transient Thermal Impedance



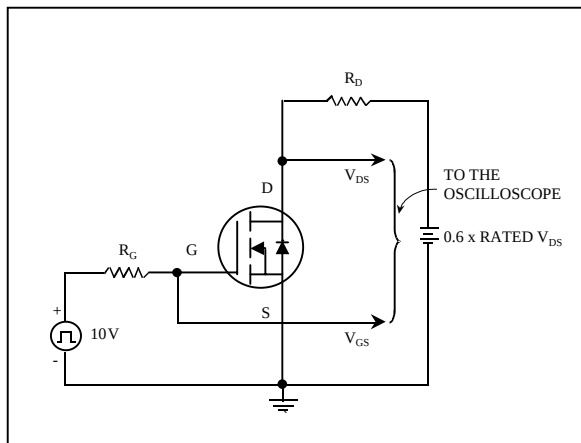


Fig 13. Switching Time Circuit

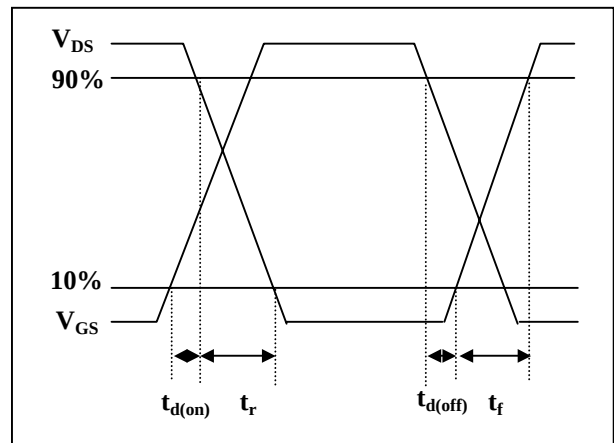


Fig 14. Switching Time Waveform

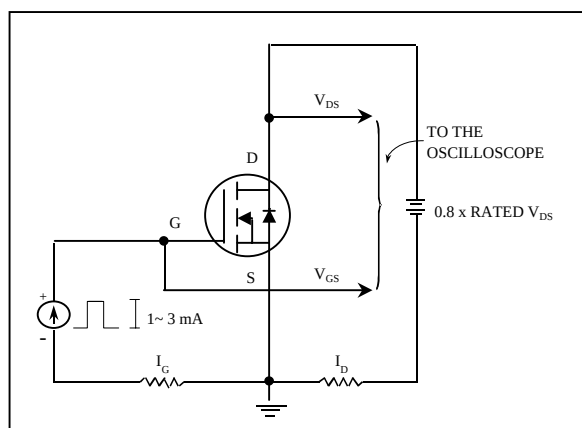


Fig 15. Gate Charge Circuit

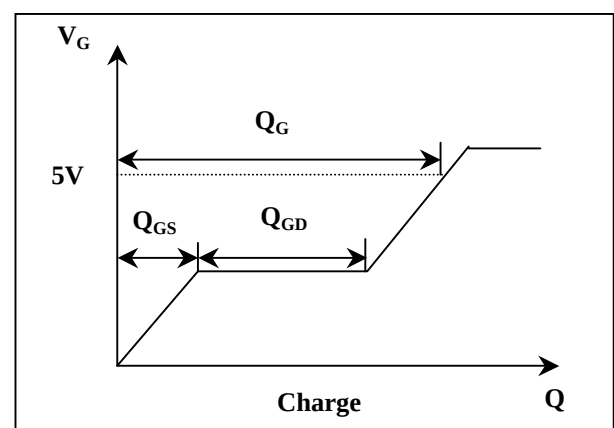
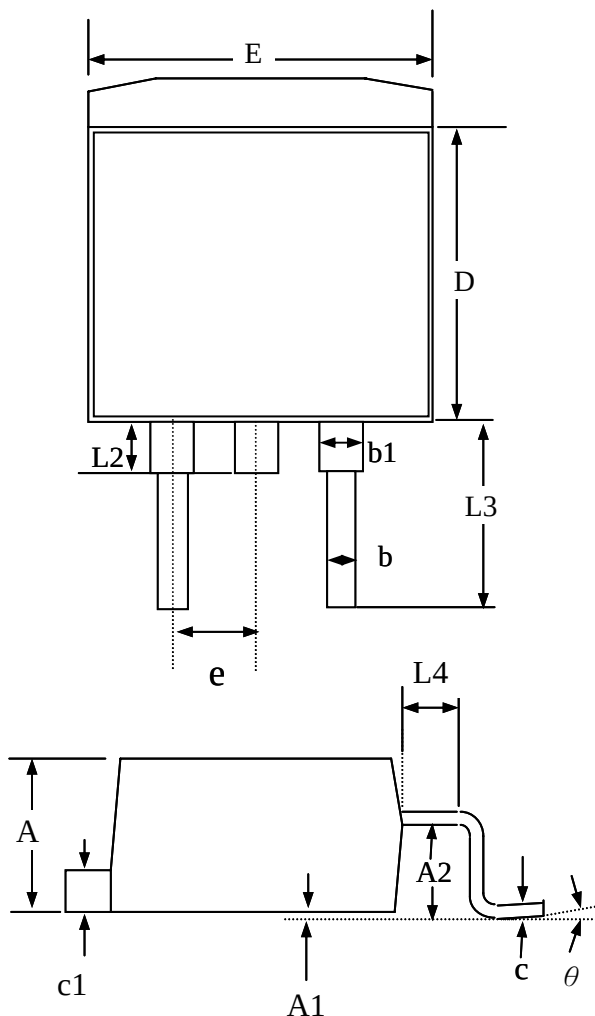


Fig 16. Gate Charge Waveform



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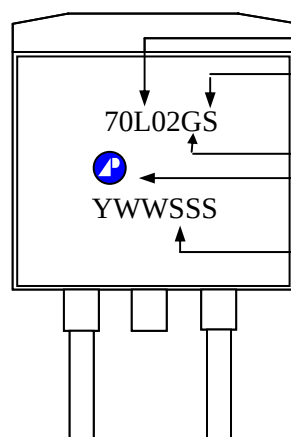
Package Outline : TO-263



SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	4.25	4.75	5.20
A1	0.00	0.15	0.30
A2	2.20	2.45	2.70
b	0.70	0.90	1.10
b1	1.07	1.27	1.47
c	0.30	0.45	0.60
c1	1.15	1.30	1.45
D	8.30	8.90	9.40
E	9.70	10.10	10.50
e	2.04	2.54	3.04
L2	-----	1.50	-----
L3	4.50	4.90	5.30
L4	-----	1.50	----

- 1.All Dimensions Are in Millimeters.
- 2.Dimension Does Not Include Mold Protrusions.

Part Marking Information & Packing : TO-263



meet Rohs requirement

Date Code (YWWSSS)

Y : Last Digit Of The Year

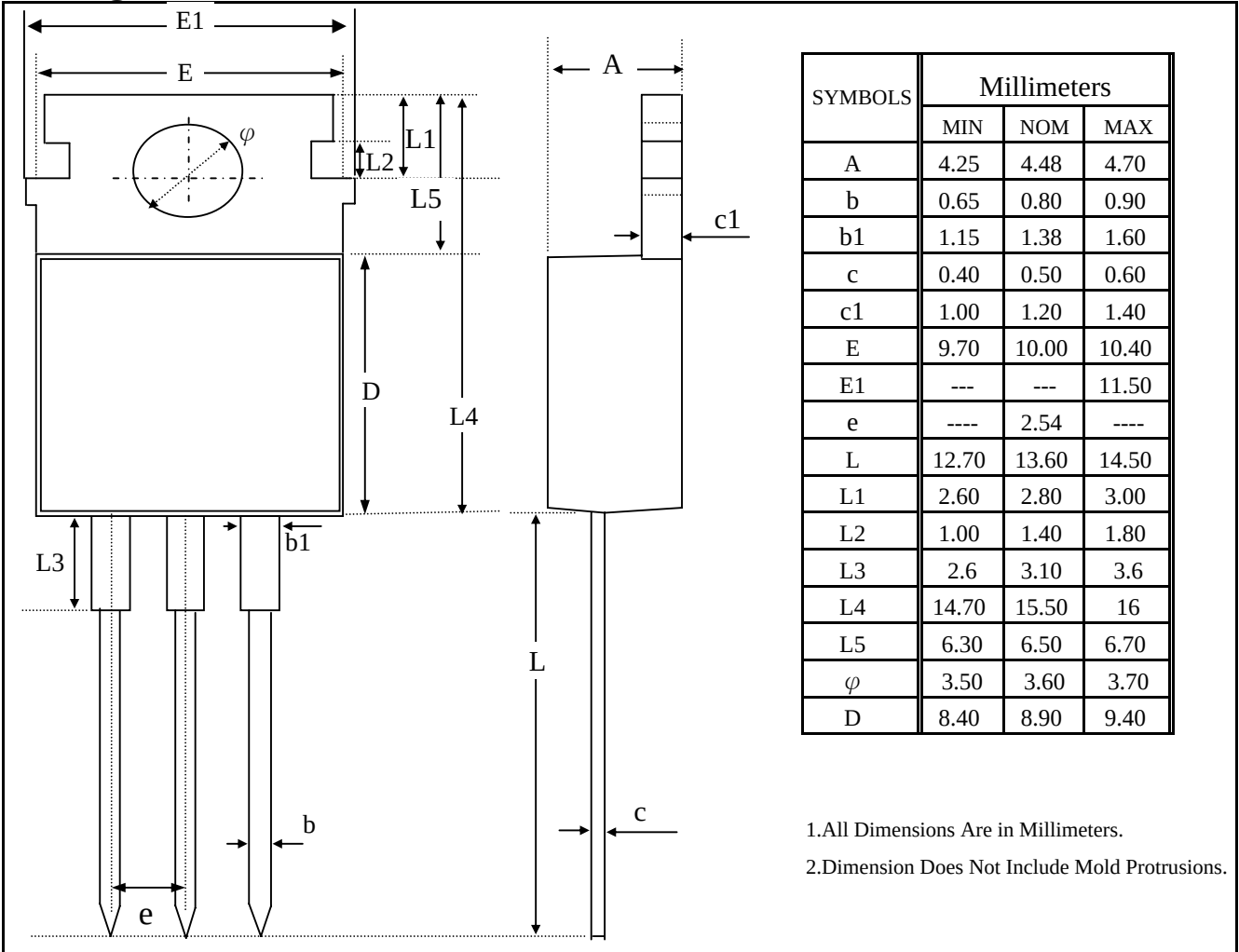
WW : Week

SSS : Sequence



ADVANCED POWER ELECTRONICS CORP.

Package Outline : TO-220



Part Marking Information & Packing : TO-220

